

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE3400 uses advanced trench technology to provide excellent $R_{\rm DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

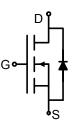
• $V_{DS} = 30V, I_D = 5.8A$

 $R_{DS(ON)}$ < 59m Ω @ V_{GS} =2.5V

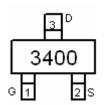
 $R_{DS(ON)}$ < 45m Ω @ V_{GS} =4.5V

 $R_{DS(ON)}$ < 41m Ω @ V_{GS} =10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package
- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



SOT-23 top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3400	NCE3400	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _G S	±12	V
Drain Current-Continuous	I _D	5.8	Α
Drain Current-Pulsed (Note 1)	I _{DM}	30	Α
Maximum Power Dissipation	P _D	1.4	W
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 150	$^{\circ}$

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	89	°C/W
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Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μΑ



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NCE3400

I _{GSS}	V_{GS} =±12 V , V_{DS} =0 V	-	-	±100	nA
		•			
$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	0.7	0.9	1.4	V
	V _{GS} =2.5V, I _D =4A - 45	45	59	mΩ	
R _{DS(ON)}	V _{GS} =4.5V, I _D =5A	-	31	45	mΩ
	V _{GS} =10V, I _D =5.8A	-	28	41	mΩ
g FS	V_{DS} =5 V , I_{D} =5 A	10	-	-	S
		•			
C _{lss}	\/ -4F\/\/ -0\/	-	820	-	PF
Coss		-	99	-	PF
C _{rss}	F=1.UIVIHZ	-	77	-	PF
		•			
t _{d(on)}		-	3.3	-	nS
t _r	V_{DD} =15V, R_L =2.7 Ω	-	4.8	-	nS
t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	26	-	nS
t _f		-	4	-	nS
Qg	\/ -45\/ -5.00	-	9.5	-	nC
Q _{gs}		-	1.5	-	nC
Q_{gd}	V _{GS} -4.5V	-	3	-	nC
		•			
V_{SD}	V _{GS} =0V,I _S =5.8A	-	-	1.2	V
Is			_	5.8	Α
	V _{GS(th)} R _{DS(ON)} gFS C _{Iss} C _{oss} C _{rss} t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} V _{SD}	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

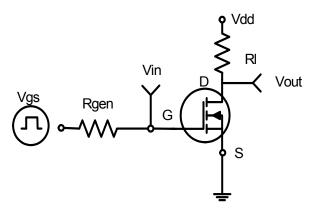


Figure 1:Switching Test Circuit

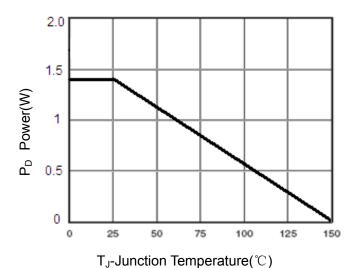


Figure 3 Power Dissipation

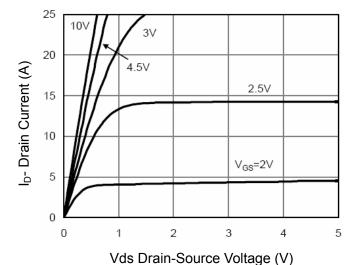


Figure 5 Output Characteristics

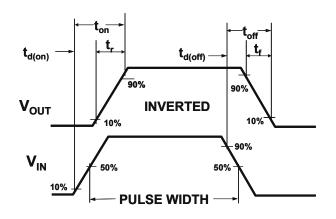


Figure 2:Switching Waveforms

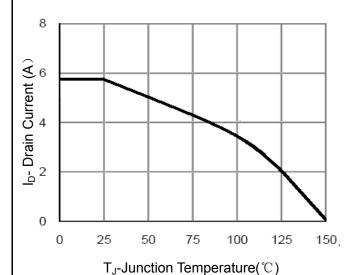


Figure 4 Drain Current

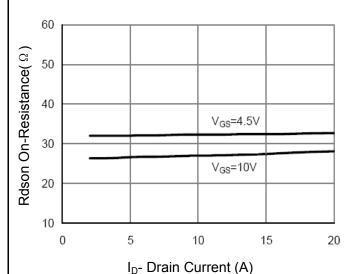


Figure 6 Drain-Source On-Resistance



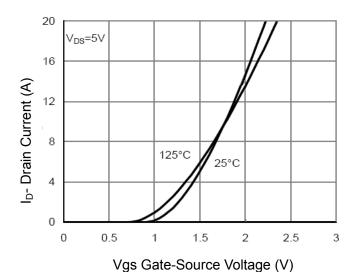
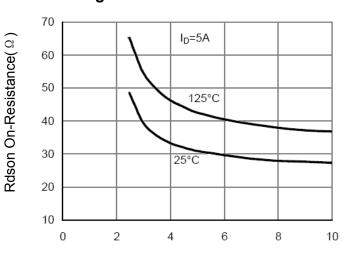


Figure 7 Transfer Characteristics



Vgs Gate-Source Voltage (V)

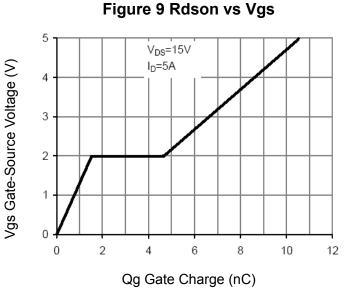


Figure 11 Gate Charge

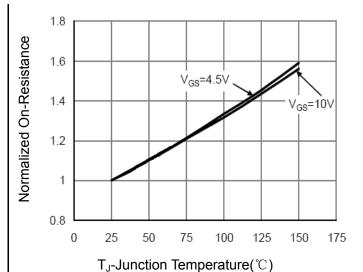


Figure 8 Drain-Source On-Resistance

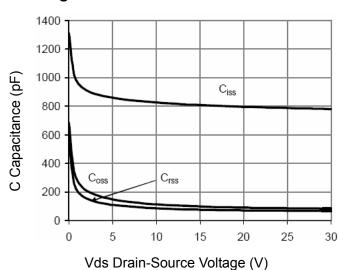


Figure 10 Capacitance vs Vds

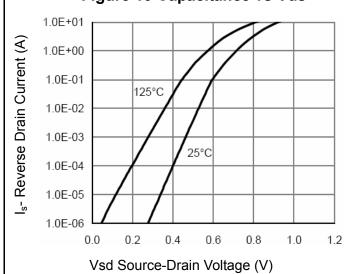


Figure 12 Source- Drain Diode Forward



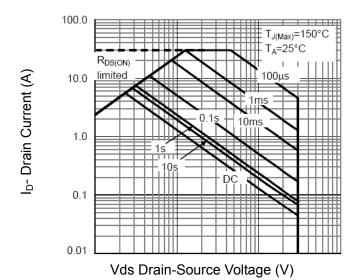


Figure 13 Safe Operation Area

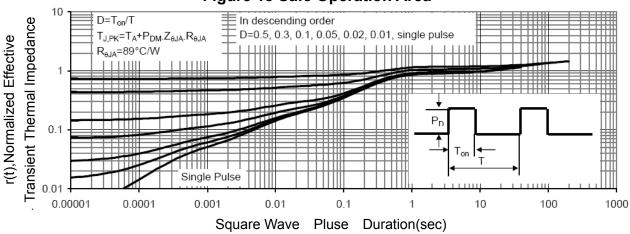
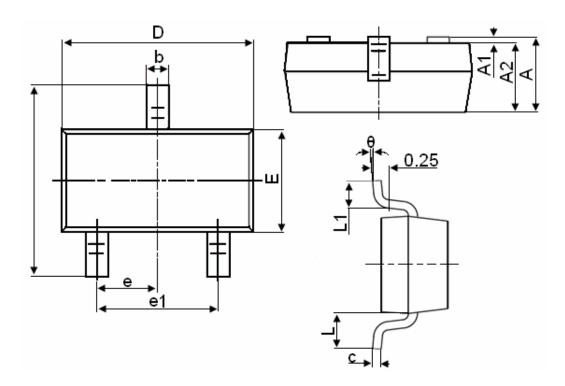


Figure 14 Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
Α	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
Е	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L		0.550REF			
L1	0.300	0.500			
θ	0°	8°			

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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Pb Free Product

NCE3400

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